

IN THE CLAIMS

1. (Original) A bond tool for attaching a wire to a bond, comprising:
 - a guide portion for guiding the wire;
 - a grooving portion adjacent to the guide portion for forming a groove in the bond; and
 - a staking portion adjacent to the grooving portion for closing the groove, wherein the guide portion, grooving portion, and staking portion are all located on the bond tool.
2. (Original) The bond tool of Claim 1, wherein the guide portion and the staking portion are approximately V-shaped and the grooving portion is an approximately inverted V-shape.
3. (Original) The bond tool of Claim 2, wherein the staking portion has a shallower V-shape than the guide portion.
4. (Original) The bond tool of Claim 1, wherein the wire is a filament.
5. (Original) The bond tool of Claim 1, wherein the attaching is with ultrasonic energy and pressure.
6. (Original) The bond tool of Claim 1, wherein the bond is an aluminum bond.
7. (Currently amended) A bond head for attaching a wire to a bond, comprising:
 - a rotatable spool containing the wire;

ASAPHERSON, KWOK CHEN
& HEID LLP
1762 TECHNOLOGY DRIVE
SUITE 226
SAN JOSE, CA 95110
(949) 752-7040
FAX (949) 752-7049

a dancer arm assembly comprising an arm and a pulley connected to the arm, wherein the wire is laid out from the spool and along the pulley;

a bond tool for attaching the wire to the bond, wherein the bond tool comprises a guide section, a grooving section, and a staking section; and

a clamp located between the pulley and the bond tool.

8. (Canceled)

9. (Original) The bond head of Claim 7, wherein the attaching is with ultrasonic energy and pressure.

10. (Currently amended) The bond head of Claim 8 7, wherein the grooving section forms a groove in the bond.

11. (Original) The bond head of Claim 10, wherein the staking section closes the groove over the wire in the bond.

12. (Original) The bond head of Claim 7, wherein the clamp comprises:

a first clamp half; and

an opposing second clamp half, wherein each clamp half has a first opening for entry of the wire, a second opening for exit of the wire, and a gripping region, with the entry and exit wider than the gripping region.

13. (Original) The bond head of Claim 12, wherein the first and second clamp halves have opposing curved portions forming the first opening.

McPHERSON, KWOK CHEN
& HEID LLP
1762 TECHNOLOGY DRIVE
SUITE 226
SAN JOSE, CA 95110
(949) 752-7040
FAX (949) 752-7049

14. (Original) The bond head of Claim 12, wherein the first clamp half is fixed and the second clamp half is moveable.

15. (Currently amended) A clamp for holding a wire from a spool, comprising:

a first clamp arm having a curved first portion and a second portion, wherein the curved first portion is closer to the spool than the second portion; and

an opposing second clamp arm having a curved first portion and a second portion, wherein the curved first portion is closer to the spool than the second portion, and wherein an opening formed from the two curved first portions is wider than a gripping region formed from the two second portions, and wherein the wire enters the clamp through the first curved portions and exits the clamp from the second curved portions.

16. (Original) The clamp of Claim 15, wherein the first clamp arm is fixed and the second clamp arm is moveable.

17. (Original) The clamp of Claim 15, wherein opposing sides of the first and second clamp arms diverge from the gripping region to a second opening opposite the first opening.

18. (Original) A method of attaching a wire to a bond, comprising:

forming a groove in the bond;

placing the wire in the groove; and

closing the groove around the wire.

McKIBERSON, KWOK CHEN
& HEID LLP
1702 TECHNOLOGY DRIVE
SUITE 336
SAN JOSE, CA 95110
(949) 752-7040
FAX (949) 752-7049

19. (Original) The method of Claim 18, wherein the forming is by ultrasonic energy and pressure.

20. (Original) The method of Claim 19, wherein the pressure is from pressing a bond tool with a grooving portion onto the bond.

21. (Original) The method of Claim 20, wherein the bond tool moves in an approximately perpendicular direction to the bond.

22. (Original) The method of Claim 18, wherein the closing is by ultrasonic energy and pressure.

23. (Original) The method of Claim 22, wherein the pressure is from pressing a bond tool with a staking portion onto the bond.

24. (Original) The method of Claim 22, wherein the staking portion has an inverted V shape.

25. (Original) The method of Claim 18, wherein the forming, placing, and closing is performed with a single pass of a bond head.

26. (Original) The method of Claim 18, wherein the wire is a filament.

27. (Original) The method of Claim 18, wherein the bond is an aluminum wire bond.

MacPHERSON, KWOK CHEN
& HEID LLP
1762 TECHNOLOGY DRIVE
SUITE 205
SAN JOSE, CA 95110
(949) 752-7040
FAX (949) 752-7049